

## General Description

The GreenMOS<sup>®</sup> high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS<sup>®</sup> Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

## Features

- Low  $R_{DS(ON)}$  & FOM
- Extremely low switching loss
- Excellent stability and uniformity




## Applications

- PC power
- LED lighting
- Telecom power
- Server power
- EV Charger
- Solar/UPS

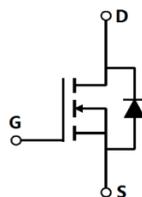
## Key Performance Parameters

| Parameter                      | Value | Unit       |
|--------------------------------|-------|------------|
| $V_{DS, min} @ T_{j(max)}$     | 700   | V          |
| $I_{D, pulse}$                 | 21    | A          |
| $R_{DS(ON)}, max @ V_{GS}=10V$ | 760   | m $\Omega$ |
| $Q_g$                          | 7.4   | nC         |

## Marking Information

| Product Name | Package | Marking    |
|--------------|---------|------------|
| OSG65R760PF  | TO220   | OSG65R760P |

## Package & Pin Information



**Absolute Maximum Ratings** at  $T_j=25^\circ\text{C}$  unless otherwise noted

| Parameter   | Symbol         | Value      | Unit             |
|---|----------------|------------|------------------|
| Drain-source voltage  | $V_{DS}$       | 650        | V                |
| Gate-source voltage   | $V_{GS}$       | $\pm 30$   | V                |
| Continuous drain current <sup>1)</sup> , $T_C=25^\circ\text{C}$         | $I_D$          | 7          | A                |
| Continuous drain current <sup>1)</sup> , $T_C=100^\circ\text{C}$        |                | 4.4        |                  |
| Pulsed drain current <sup>2)</sup> , $T_C=25^\circ\text{C}$             | $I_{D, pulse}$ | 21         | A                |
| Continuous diode forward current <sup>1)</sup> , $T_C=25^\circ\text{C}$ | $I_S$          | 7          | A                |
| Diode pulsed current <sup>2)</sup> , $T_C=25^\circ\text{C}$             | $I_{S, pulse}$ | 21         | A                |
| Power dissipation <sup>3)</sup> , $T_C=25^\circ\text{C}$                | $P_D$          | 37         | W                |
| Single pulsed avalanche energy <sup>5)</sup>                            | $E_{AS}$       | 130        | mJ               |
| MOSFET dv/dt ruggedness, $V_{DS}=0\dots 480\text{ V}$                   | dv/dt          | 50         | V/ns             |
| Reverse diode dv/dt, $V_{DS}=0\dots 480\text{ V}$ , $I_{SD}\leq I_D$    | dv/dt          | 15         | V/ns             |
| Operation and storage temperature                                       | $T_{stg}, T_j$ | -55 to 150 | $^\circ\text{C}$ |

**Thermal Characteristics**

| Parameter  | Symbol          | Value | Unit               |
|--|-----------------|-------|--------------------|
| Thermal resistance, junction-case                  | $R_{\theta JC}$ | 3.4   | $^\circ\text{C/W}$ |
| Thermal resistance, junction-ambient <sup>4)</sup> | $R_{\theta JA}$ | 62    | $^\circ\text{C/W}$ |

**Electrical Characteristics** at  $T_j=25^\circ\text{C}$  unless otherwise specified

| Parameter                        | Symbol       | Min. | Typ. | Max. | Unit          | Test condition   |
|----------------------------------|--------------|------|------|------|---------------|--|
| Drain-source breakdown voltage   | $BV_{DSS}$   | 650  |      |      | V             | $V_{GS}=0\text{ V}$ , $I_D=250\ \mu\text{A}$                           |
|                                  |              | 700  | 750  |      |               | $V_{GS}=0\text{ V}$ , $I_D=250\ \mu\text{A}$ , $T_j=150^\circ\text{C}$ |
| Gate threshold voltage           | $V_{GS(th)}$ | 2.0  |      | 4.0  | V             | $V_{DS}=V_{GS}$ , $I_D=250\ \mu\text{A}$                               |
| Drain-source on-state resistance | $R_{DS(on)}$ |      | 0.66 | 0.76 | $\Omega$      | $V_{GS}=10\text{ V}$ , $I_D=3.5\text{ A}$                              |
|                                  |              |      | 1.6  |      |               | $V_{GS}=10\text{ V}$ , $I_D=3.5\text{ A}$ , $T_j=150^\circ\text{C}$    |
| Gate-source leakage current      | $I_{GSS}$    |      |      | 100  | nA            | $V_{GS}=30\text{ V}$   |
|                                  |              |      |      | -100 |               | $V_{GS}=-30\text{ V}$  |
| Drain-source leakage current     | $I_{DSS}$    |      |      | 1    | $\mu\text{A}$ | $V_{DS}=650\text{ V}$ , $V_{GS}=0\text{ V}$                            |

### Dynamic Characteristics

| Parameter                    | Symbol       | Min. | Typ.  | Max. | Unit | Test condition  |
|------------------------------|--------------|------|-------|------|------|---|
| Input capacitance            | $C_{iss}$    |      | 354.2 |      | pF   | $V_{GS}=0\text{ V}$ ,<br>$V_{DS}=50\text{ V}$ ,<br>$f=1\text{ MHz}$                         |
| Output capacitance           | $C_{oss}$    |      | 31.4  |      | pF   |   |
| Reverse transfer capacitance | $C_{rss}$    |      | 1.54  |      | pF   |   |
| Turn-on delay time           | $t_{d(on)}$  |      | 17.6  |      | ns   | $V_{GS}=10\text{ V}$ ,<br>$V_{DS}=400\text{ V}$ ,<br>$R_G=25\ \Omega$ ,<br>$I_D=5\text{ A}$ |
| Rise time                    | $t_r$        |      | 11.4  |      | ns   |   |
| Turn-off delay time          | $t_{d(off)}$ |      | 27.2  |      | ns   |   |
| Fall time                    | $t_f$        |      | 24.4  |      | ns   |   |

### Gate Charge Characteristics

| Parameter            | Symbol        | Min. | Typ. | Max. | Unit | Test condition  |
|----------------------|---------------|------|------|------|------|---|
| Total gate charge    | $Q_g$         |      | 7.4  |      | nC   | $V_{GS}=10\text{ V}$ ,<br>$V_{DS}=400\text{ V}$ ,<br>$I_D=5\text{ A}$ |
| Gate-source charge   | $Q_{gs}$      |      | 1.9  |      | nC   |   |
| Gate-drain charge    | $Q_{gd}$      |      | 3.3  |      | nC   |   |
| Gate plateau voltage | $V_{plateau}$ |      | 5.9  |      | V    |   |

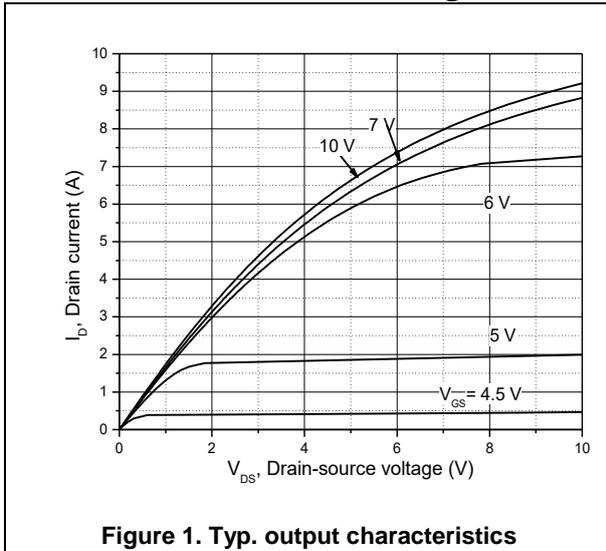
### Body Diode Characteristics

| Parameter                     | Symbol    | Min. | Typ. | Max. | Unit          | Test condition   |
|-------------------------------|-----------|------|------|------|---------------|--|
| Diode forward voltage         | $V_{SD}$  |      |      | 1.3  | V             | $I_S=7\text{ A}$ ,<br>$V_{GS}=0\text{ V}$                                      |
| Reverse recovery time         | $t_{rr}$  |      | 146  |      | ns            | $V_R=400\text{ V}$ ,<br>$I_S=5\text{ A}$ ,<br>$di/dt=100\text{ A}/\mu\text{s}$ |
| Reverse recovery charge       | $Q_{rr}$  |      | 0.98 |      | $\mu\text{C}$ |  |
| Peak reverse recovery current | $I_{rrm}$ |      | 11.6 |      | A             |  |

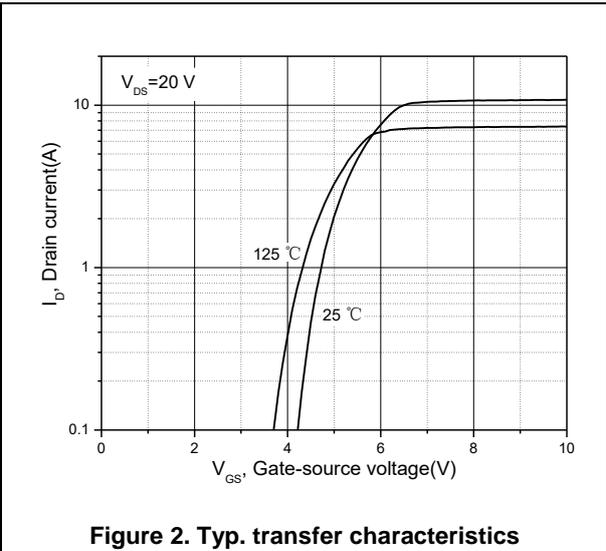
### Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25\text{ }^\circ\text{C}$ .
- 5)  $V_{DD}=50\text{ V}$ ,  $V_{GS}=10\text{ V}$ ,  $L=20\text{ mH}$ , starting  $T_j=25\text{ }^\circ\text{C}$ .

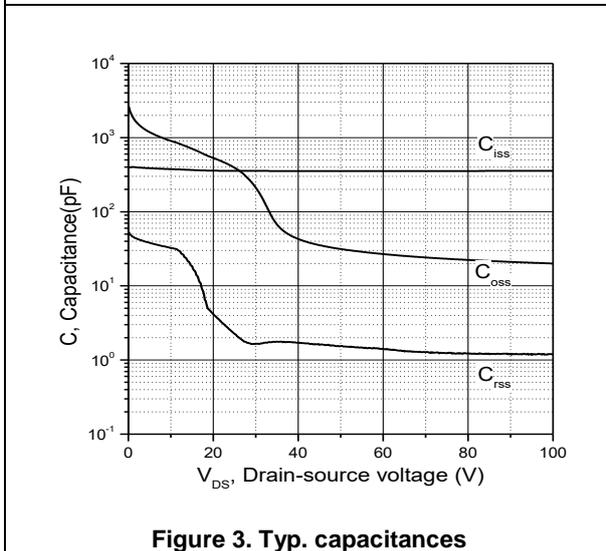
**Electrical Characteristics Diagrams**



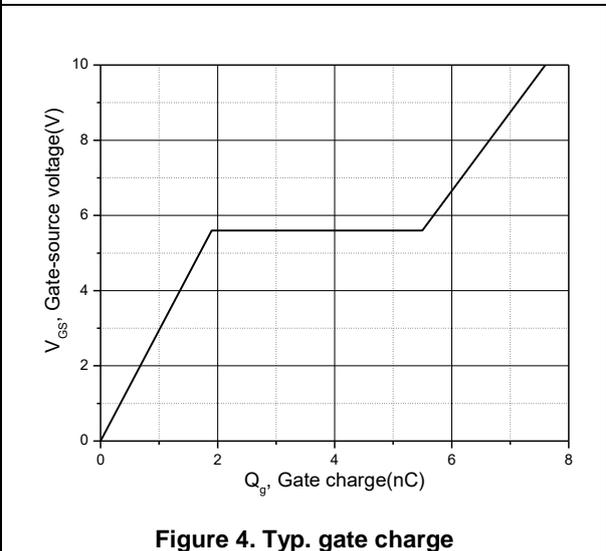
**Figure 1. Typ. output characteristics**



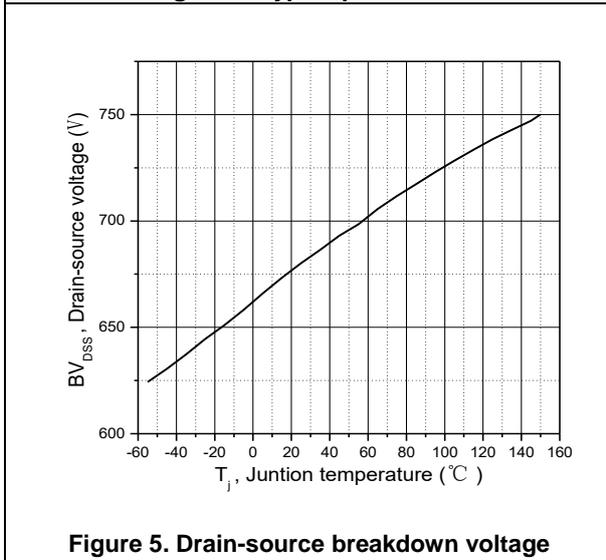
**Figure 2. Typ. transfer characteristics**



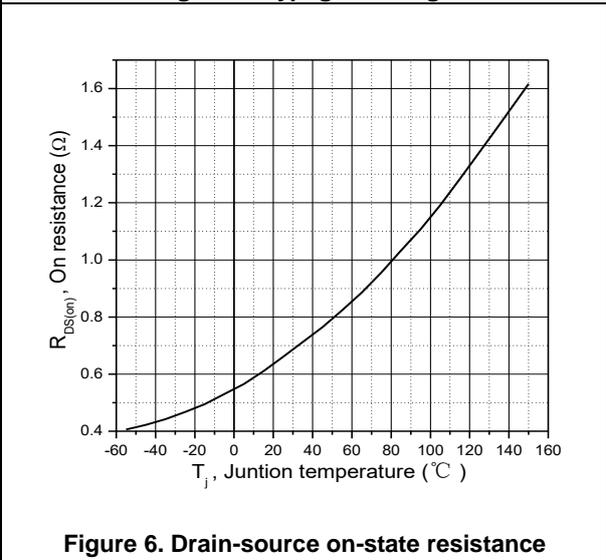
**Figure 3. Typ. capacitances**



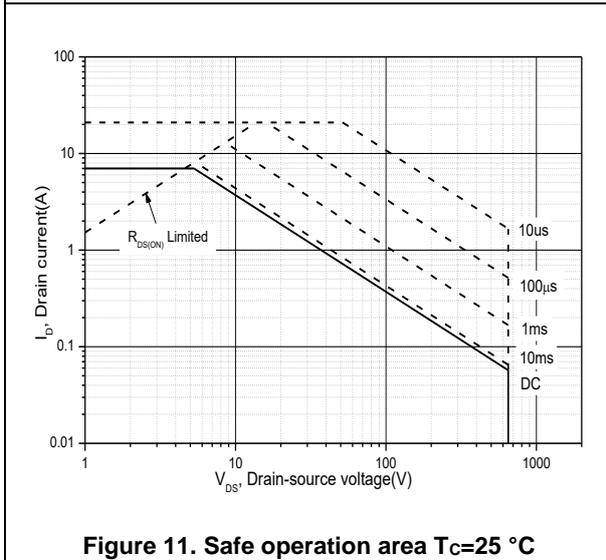
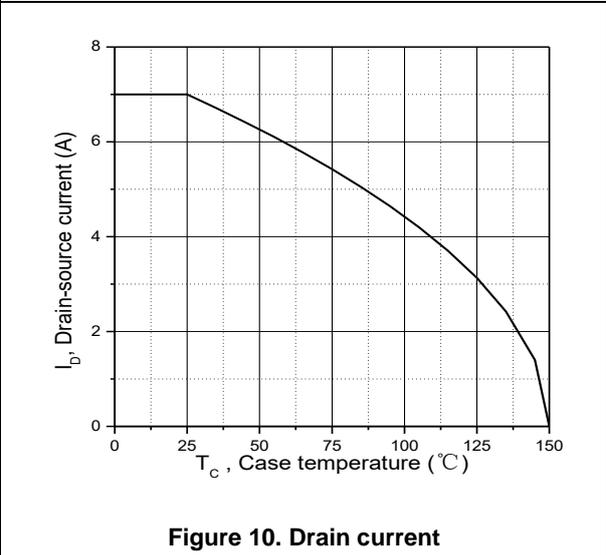
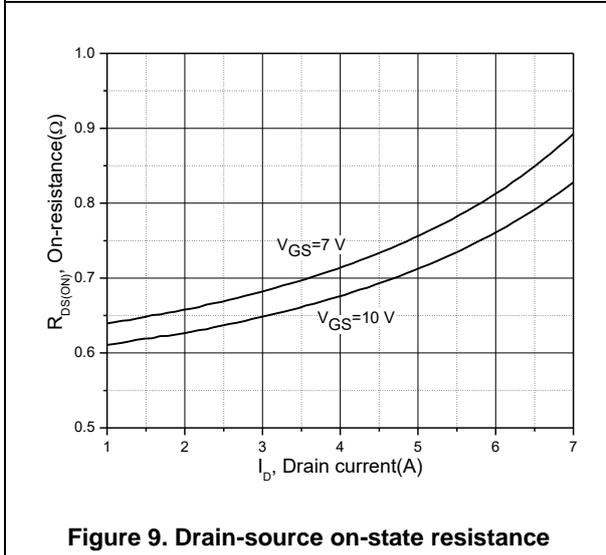
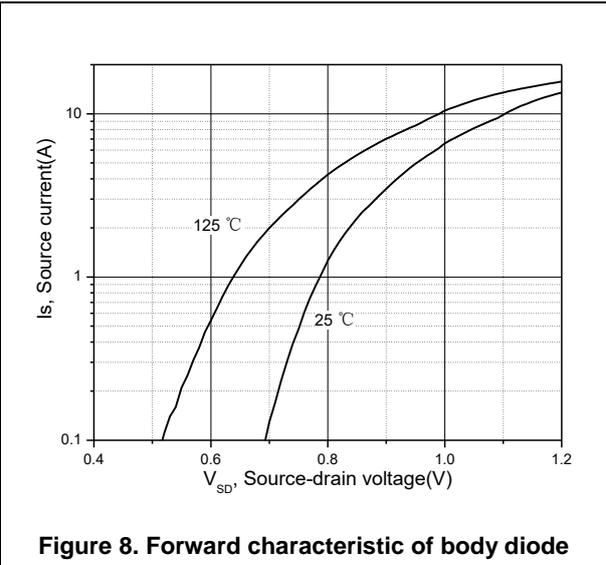
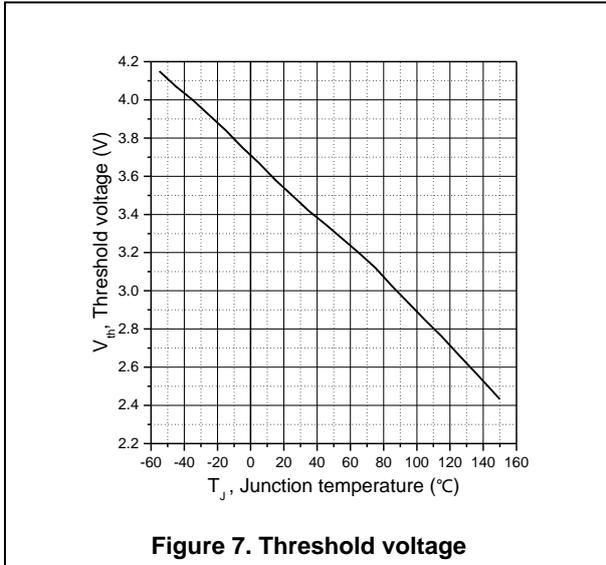
**Figure 4. Typ. gate charge**



**Figure 5. Drain-source breakdown voltage**



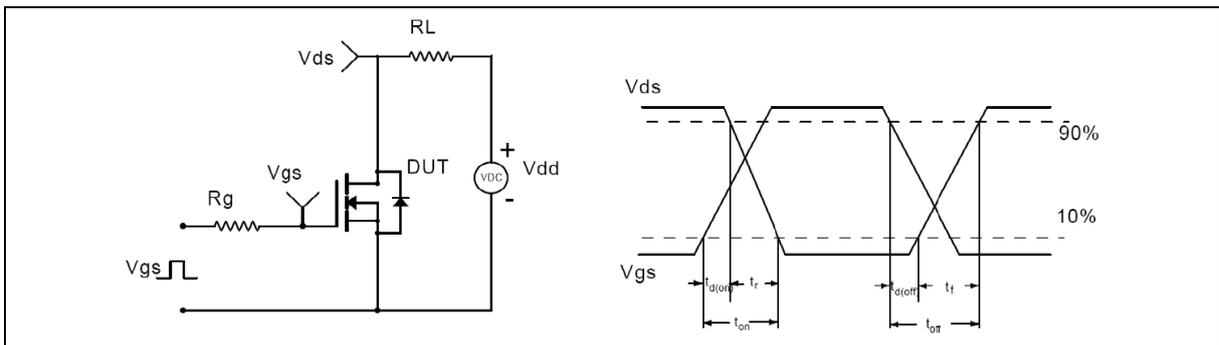
**Figure 6. Drain-source on-state resistance**



**Test circuits and waveforms**



**Figure 1. Gate charge test circuit & waveform**



**Figure 2. Switching time test circuit & waveforms**

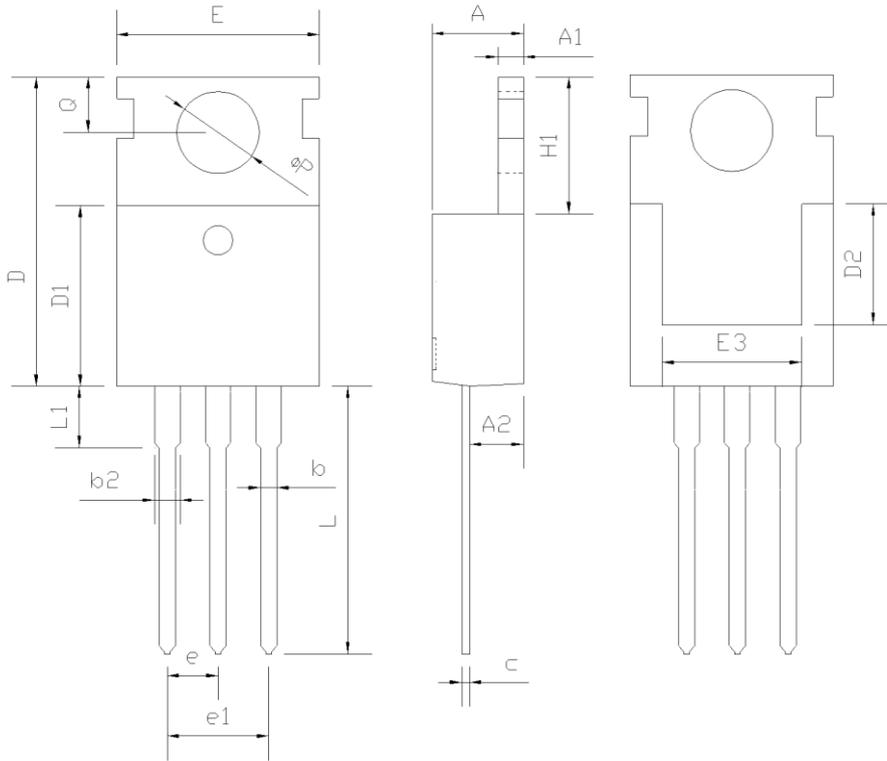


**Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms**



**Figure 4. Diode reverse recovery test circuit & waveforms**

**Package Information**



| Symbol | mm      |       |       |
|--------|---------|-------|-------|
|        | Min     | Nom   | Max   |
| A      | 4.37    | 4.57  | 4.77  |
| A1     | 1.25    | 1.30  | 1.45  |
| A2     | 2.20    | 2.40  | 2.60  |
| b      | 0.70    | 0.80  | 0.95  |
| b2     | 1.17    | 1.27  | 1.47  |
| c      | 0.40    | 0.50  | 0.65  |
| D      | 15.10   | 15.60 | 16.10 |
| D1     | 8.80    | 9.10  | 9.40  |
| D2     | 5.50    | -     | -     |
| E      | 9.70    | 10.00 | 10.30 |
| E3     | 7.00    | -     | -     |
| e      | 2.54BSC |       |       |
| e1     | 5.08BSC |       |       |
| H1     | 6.25    | 6.50  | 6.85  |
| L      | 12.75   | 13.50 | 13.80 |
| L1     | -       | 3.10  | 3.40  |
| ΦP     | 3.40    | 3.60  | 3.80  |
| Q      | 2.60    | 2.80  | 3.00  |

Version 1: TO220-P package outline dimension

## Ordering Information

| Package Type | Units/ Tube | Tubes/ Inner Box | Units/ Inner Box | Inner Boxes/ Carton Box | Units/ Carton Box |
|--------------|-------------|------------------|------------------|-------------------------|-------------------|
| TO220-P      | 50          | 20               | 1000             | 6                       | 6000              |

## Product Information

| Product     | Package | Pb Free | RoHS | Halogen Free |
|-------------|---------|---------|------|--------------|
| OSG65R760PF | TO220   | yes     | yes  | yes          |

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